

### **Low Drop LED Driver IC**

## **Feature list**

- Supply voltage from 6 V to 42 V
- · Controls up to 100 mA LED current
- Typ. 135 mV saturation voltage at 50 mA
- LED current precision ±5 % at 95mA
- · Smart over temperature protection function

# Advantages with respect to discrete solutions

- Low BOM count
- Lower assembly cost
- Smaller form factor
- Higher reliability due to less parts and soldering joints

# **Potential Applications**

- LED strips
- LED displays and channel letters
- Architectural and landscape lighting
- Retail lighting

#### **Product Validation**

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22

Product Name	Package	Marking
BCR430U	PG-SOT23-6-1	43

# **Description**

BCR430U is a linear LED controller IC in a small PG-SOT23-6-1 package regulating the LED current in standalone operation without any external power transistor. The IC supply voltage range is from 6 V up to 42 V. The LED current level can be adjusted up to 100 mA connecting a high ohmic resistor Rset to pin RS. The voltage drop at the integrated LED driver stage is less than 200 mV at 50 mA improving the overall system efficiency and providing extra voltage headroom to compensate for tolerances of LED forward voltage or supply voltage. The smart over temperature protection function reduces the LED current when junction temperature of BCR430U is very high.

# **Low Drop LED Driver IC**



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**Application circuit** 

#### **Application circuit** 1

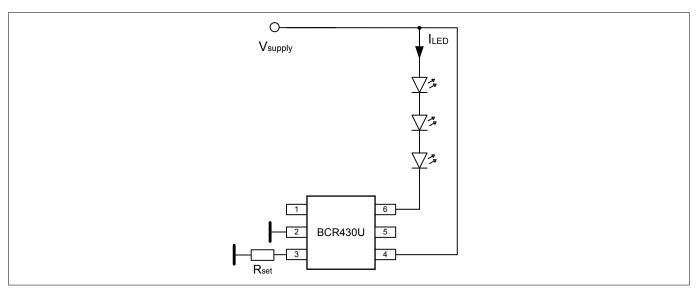


Figure 1 **Typical Application Circuit of BCR430U** 

#### **Pin configuration** 2

Pin No.	Pin Name	Pin Type	Function
1	N.C.	-	Not connected
2	GND	GND	IC ground & thermal connection to heat spreader on PCB
3	RS	Output	Connection of Rset resistor
4	VS	Input	Supply voltage
5	N.C.	-	Not connected
6	LED	Input	Driver pin to control the LED current

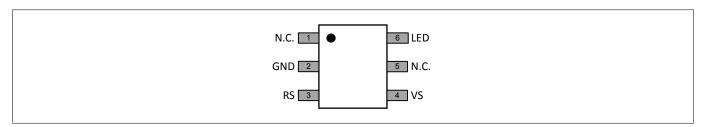


Figure 2 **Pinout BCR430** 



**Functional description** 

#### **Functional description** 3

#### **LED** current configuration

The LED current is configured by the external resistor Rset at pin RS. The current flowing into pin LED is proportional to the current flowing out of pin RS by a ratio of about 520:1. Therefore, the LED current depends on the value of Rset.

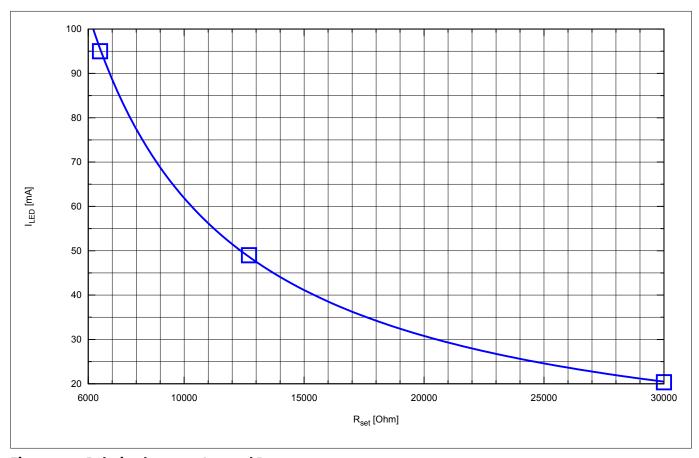


Figure 3 Relation between I<sub>LED</sub> and R<sub>set</sub>

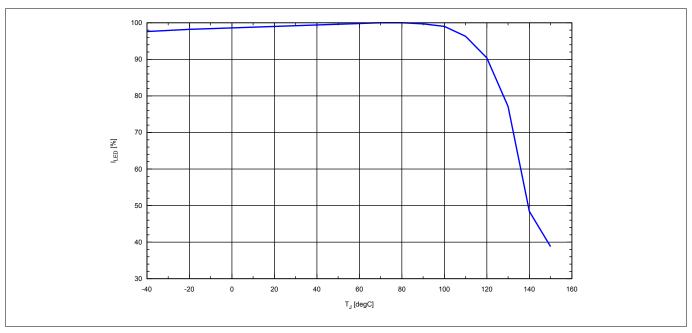
# **Low Drop LED Driver IC**



**Functional description** 

#### **Smart over temperature protection function**

BCR430U reduces the LED current with increasing junction temperature by reducing the voltage at pin RS. The reduced voltage of pin RS drives less current through the external resistor Rset, causing the current into pin LED to reduce. The LED current is never turned off fully.



Relative reduction of LED current versus junction temperature of BCR430U Figure 4

#### **Maximum Permitted Power Dissipation**

To avoid damage of the IC the power dissipation of BCR430U must be reduced with increasing ambient temperature according to Figure 5.

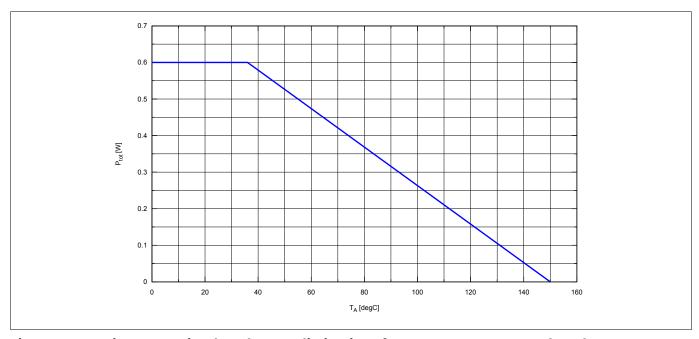


Figure 5 Maximum permitted total power dissipation of BCR430U on a JESD 51-7 board

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**Electrical characteristics and parameters** 

# 4 Electrical characteristics and parameters

Table 1 Maximum Ratings at T<sub>A</sub> = 25 °C, unless otherwise specified

Parameter	Symbol	Values			Unit	Note or test
		Min.	Тур.	Max.		condition
Junction temperature	TJ	-40	-	150	°C	
Supply voltage	Vs	0	-	45	V	
Voltage at LED pin	$V_{LED}$	0	-	20	٧	
Driver LED current	I <sub>LED</sub>	0	-	100	mA	
RS output current	I <sub>RS</sub>	0	-	0.3	mA	
Power dissipation	P <sub>tot</sub>	-	-	600	mW	
ESD robustness	V <sub>ESD,HBM</sub>	-	-	1	kV	HBM acc. to JESD22 - A11

Attention: Stresses above the max. values listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the integrated circuit.

Table 2 Thermal Resistance at  $T_A = 25$  °C, unless otherwise specified

Parameter	Symbol		Values			Note or Test
		Min.	Тур.	Max.		Condition
Thermal resistance junction to ambient	R <sub>thJA,1s0p,0</sub>	-	-	288	K/W	JEDEC 1s0p (JESD 51-3) footprint w/o extra cooling area
	R <sub>thJA,1s0p,300</sub>	-	-	182	K/W	JEDEC 1s0p (JESD 51-3) with 300 mm <sup>2</sup> cooling area connected to GND pin
	R <sub>thJA,2s2p</sub>	-	-	190	K/W	JEDEC 2s2p (JESD 51-7)

Table 3 Electrical Characteristics at T<sub>A</sub> = 25 °C, unless otherwise specified

Parameter	Symbol	Values		<b>Values</b> Unit		Note or Test
		Min.	Тур.	Max.		Condition
Supply voltage	V <sub>S</sub>	6	-	42	V	Operational voltage range
Supply current	Is	1.2	1.7	2.2	mA	I <sub>LED</sub> = 50 mA, V <sub>S</sub> = 6 V
		1.3	1.8	2.3		I <sub>LED</sub> = 50 mA, V <sub>S</sub> = 42 V
Driver LED current range	I <sub>LED</sub>	5	-	100	mA	

# **BCR430U Preliminary Datasheet**Low Drop LED Driver IC



## **Electrical characteristics and parameters**

Table 3 Electrical Characteristics at T<sub>A</sub> = 25 °C, unless otherwise specified (continued)

Parameter	Symbol		Values			Note or Test
		Min.	Min. Typ. Max.	Condition		
Driver LED current by R <sub>set</sub>	I <sub>LED</sub>	18.0	20.4	22.7	mA	$R_{set} = 30 \text{ k}\Omega$
		45.7	49	52.3		$R_{set} = 12.7 \text{ k}\Omega$
		90	95	100		$R_{set} = 6.49 \text{ k}\Omega$
Driver saturation voltage	V <sub>LED,sat</sub>	70	135	200	mV	I <sub>LED</sub> = 50 mA
RS pin voltage	V <sub>RS</sub>	1.16	1.20	1.24	٧	$I_{RS} = 0 \mu A$
		1.15	1.19	1.23		I <sub>RS</sub> = 200 μA

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**Package dimensions** 

#### **Package dimensions** 5

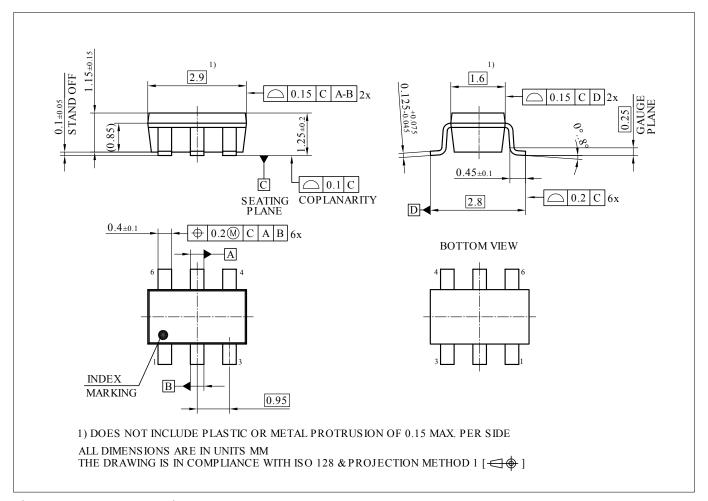


Figure 6 Package outline PG-SOT23-6-1



## Package dimensions

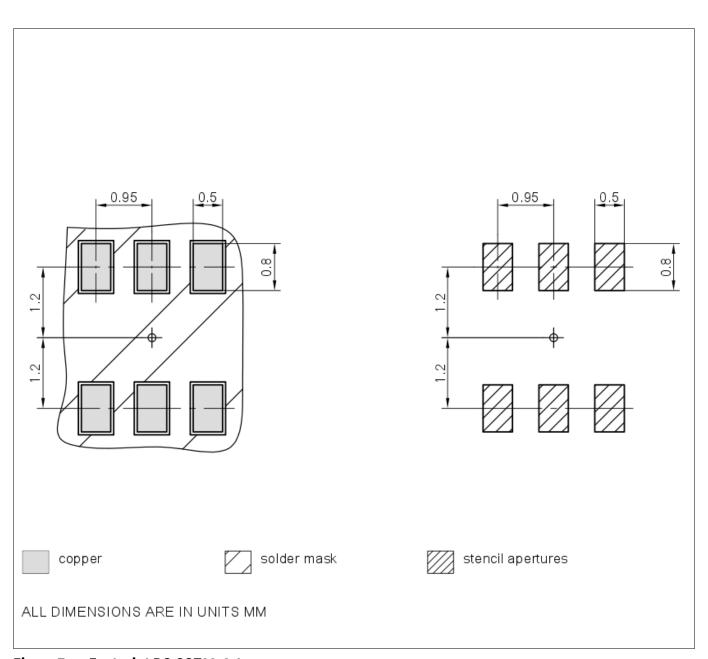


Figure 7 Footprint PG-SOT23-6-1

## **Low Drop LED Driver IC**



#### References

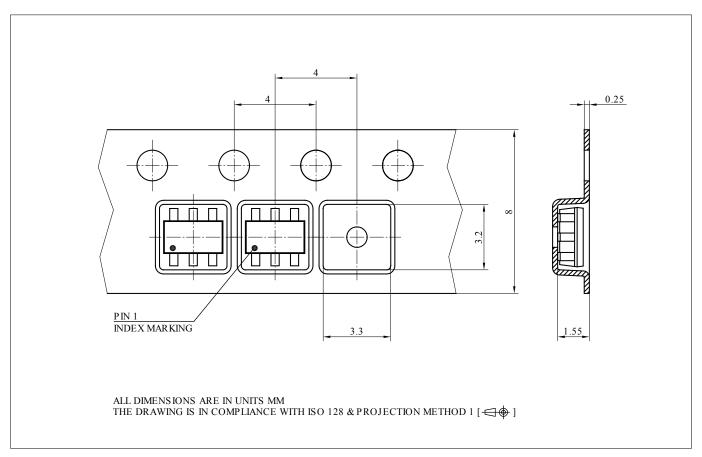


Figure 8 Tape & Reel PG-SOT23-6-1

## 6 References

# **Revision history**

Document version	Date of release	Description of changes	
1.0	2017-06-26	First version of preliminary data sheet	

#### **Trademarks**

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